Taiwan Semiconductor

# 1A, 100V - 200V Ultra Fast Surface Mount Rectifier

### FEATURES

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency switching
- DC/DC
- Snubber

### **MECHANICAL DATA**

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.015g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I <sub>F</sub>	1	А
V <sub>RRM</sub>	100 - 200	V
I <sub>FSM</sub>	45	А
T <sub>J MAX</sub>	175	°C
Package	SOD-123W	
Configuration	Single die	









ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PU1BLW	PU1DLW	UNIT
Marking code on the device			U1BLW	U1DLW	
Repetitive peak reverse voltage		V <sub>RRM</sub>	100	200	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	70	140	V
Forward current		١ <sub>F</sub>	1		А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms		45 100		٨
	t = 1.0ms	I <sub>FSM</sub>			A
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T <sub>STG</sub>	-55 to +175		°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R <sub>ƏJL</sub>	18	°C/W
Junction-to-ambient thermal resistance	R <sub>eja</sub>	80	°C/W
Junction-to-case thermal resistance	R <sub>θJC</sub>	22	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 0.5A, T_J = 25^{\circ}C$		0.79	-	V
	$I_F = 1.0A, T_J = 25^{\circ}C$		0.84	0.93	V
	$I_F = 0.5A, T_J = 125^{\circ}C$	V <sub>F</sub>	0.64	-	V
	$I_F = 1.0A, T_J = 125^{\circ}C$		0.70	-	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$	- I <sub>R</sub>	-	2	μA
	T <sub>J</sub> = 125°C		-	10	μA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	19	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$		-	25	ns
	$I_F = 1.0A$ , di/dt = 50A/µs, $V_R = 30V$	t <sub>rr</sub>	34	-	
Reverse recovery current		I <sub>RM</sub>	3.4	-	Α
Reverse recovery charge	$I_F = 1.0A$ , di/dt = 200A/µs, $V_R = 100V$	Q <sub>rr</sub>	27	-	nC
Reverse recovery time	]	t <sub>rr</sub>	19	-	ns

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
PU1xLW	SOD-123W	10,000/ Tape & Reel

Notes:

1. "x" defines voltage from 100V(PU1BLW) to 200V(PU1DLW)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

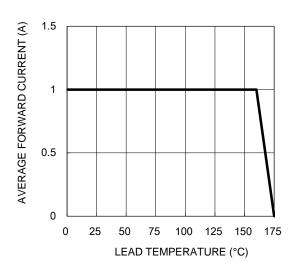
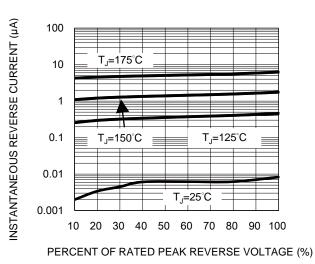


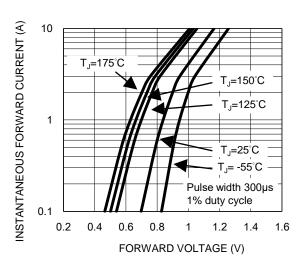
Fig.1 Forward Current Derating Curve

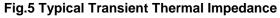
#### **Fig.3 Typical Reverse Characteristics**



 $(H) = 100 \\ (H) = 100 \\ (H)$ 

Fig.4 Typical Forward Characteristics





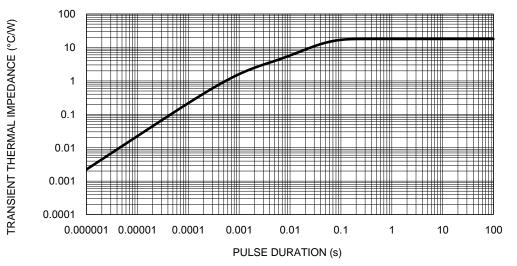


Fig.2 Typical Junction Capacitance

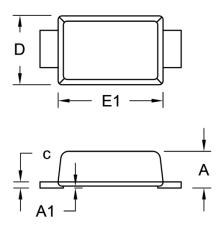
Taiwan Semiconductor

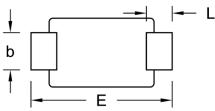
# PACKAGE OUTLINE DIMENSIONS

TAIWAN SEMICONDUCTOR

**9**Ъ

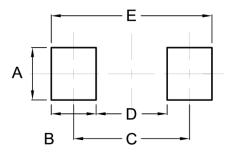
SOD-123W





#### Unit (mm) Unit (inch) DIM. Min. Max. Min. Max. 0.90 1.02 0.035 0.040 А 0.10 0.000 A1 0.00 0.004 b 0.90 1.05 0.035 0.041 0.10 0.22 0.004 0.009 С D 1.70 1.90 0.067 0.075 Е 3.60 3.80 0.142 0.150 E1 2.90 2.60 0.102 0.114 L 0.50 0.85 0.020 0.033

# SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

# MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code
F	= Factory Code



Taiwan Semiconductor

# Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.